



Product Change Notification

Change Notification #: 115877 - 00
Change Title: Intel® Power Supply FUP550SNRPS, PCN 115877-00, Label, Add BIS regulatory mark on the PSU label
Date of Publication: October 31, 2017

Key Characteristics of the Change:
 Label Update

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	November 15, 2017
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Power Supply Unit FUP550SNRPS:

1. Add India BIS regulatory mark on the PSU label.

intel SWITCHING POWER SUPPLY
 交換式電源供應器 / 开关电源供应器
 / 컴퓨터용 전원공급장치

警告使用者: 此為甲類資訊技術設備, 於居住環境中使用時, 可能會造成射頻擾動, 在此種情況下, 使用者會被要求採取某些適當的對策。
 声明: 此为A级产品, 在生活环境中, 该产品可能会造成无线电干扰, 在这种情况下, 可能要求用户对其干扰采取切实可行的措施。

AUTORANGE INPUT 自動調整輸入 (自动调整输入): 50/60Hz
 INPUT / ENTRADA 輸(输)入: 100-127V~ 10A INPUT / ENTRADA 輸(输)入: 200-240V~ 6A 用戶對其干擾採取切實可行的措施。
 OUTPUT / SALIDA 輸(输)出: 900W MAX OUTPUT / SALIDA 輸(输)出: 1100W MAX
 +12V = 75.0A MAX +12V = 91.7A MAX
 +12Vsb = 2.1A MAX +12Vsb = 2.1A MAX

ZU10126-13008
 MSIP-REM-CPU-S-1100ADU00
 A/S 연락처: 82-2-767-2595
 Factory: Flextronics Power Systems(Dongguan) Co., Ltd

MODEL 型號(型号): S-1100ADU00-201 REV 版本: 02F

P/N G84027-008
 S/N VSP1YWWXXXXX

80 PLUS PLATINUM

Flextronics Sales & Marketing (A-P) Ltd.
 製造商: for China CCC
 中國製造/中国製造 MADE IN CHINA

S 13252(Part 1)/ IEC 60950-1
 R-41063541

WARNING 警告
 Connect only to a properly earth grounded outlet. Apparaten skall anslutas till jordat uttag. Laitte on liitettävä suojamaadoituskoskettimilla varustettuun pistorasiaan. 插座必須(須)正確(確)接地

2. FUP550SNRPS part number rolling up from E96494-007 to E96494-008.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
FUP550SNRPS	915602	G37803-002	G37803-003

PCN Revision History:

Date of Revision:
October 31, 2017

Revision Number:
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Reason:
Originally Published PCN



Product Change Notification

115877 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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